



Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 4,000pcs/ Reel
- \bullet MSL (Moisture Sensitivity Level): 3
- Halogen-free
- RoHS compliant

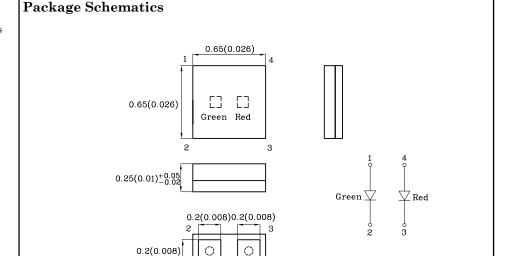






ATTENTION

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES



0.15(0.006)

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

0.2(0.008)

Absolute Maximum Ratings (T _A =25°C)		Green (InGaN)	Red (AlGaInP)	Unit
Reverse Voltage	V_{R}	5	5	V
Forward Current	I_{F}	10	10	mA
Forward Current (Peak) Duty Cycle ≤ 1/20 1ms Pulse Width	${ m I}_{ m FP}$	50	40	mA
Power Dissipation	P_{D}	35	35	mW
Electrostatic Discharge Th (HBM)	450	3000	V	
Operating Temperature	T_{A}	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +100		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Green (InGaN)	Red (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =5mA)	V_{F}	2.85	1.95	V
Forward Voltage (Max.) (I _F =5mA)	V_{F}	3.3	2.3	V
Reverse Current (Max.) $(V_R=5V)$	I_R	50	10	μА
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =5mA)	λΡ	515*	632*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =5mA)	λD	525*	624*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =5mA)	Δλ	30	20	nm

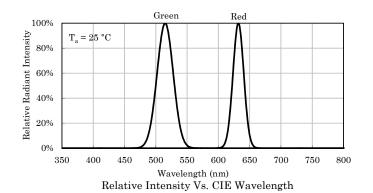
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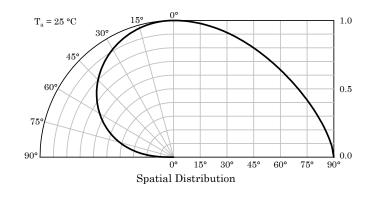
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I}_F\text{=}5\text{mA)} \\ \text{mcd} \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZDGMERKK172W ————	Green	InGaN	– Water Clear	50 50*	198 198*	515*	140°
	Red	AlGaInP	- water Clear	15 6*	74 24*	632*	

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Oct 21,2023

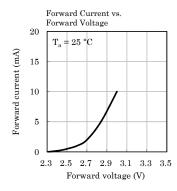
XDSB9631 V1-X Layout: Maggie L.

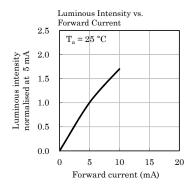


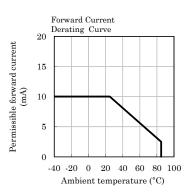


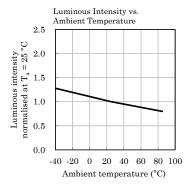


❖ Green

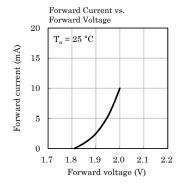


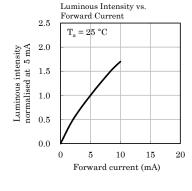


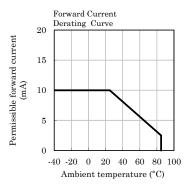


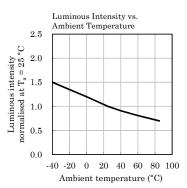


* Red





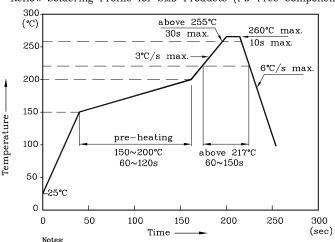






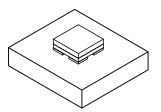
❖ LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

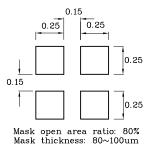


- All temperatures refer to the center of the package, measured on the package body surface facing up during reflow.
- 2. Do not apply any stress to the LED during high temperature conditions.
- 3. Maximum number of soldering passes: 2

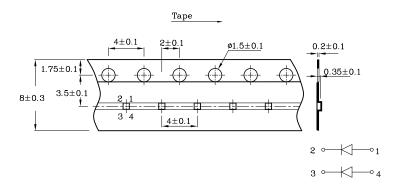
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



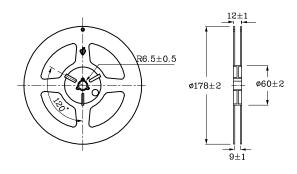
♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



* Tape Specification (Units:mm)



❖ Reel Dimension (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V
- 4. Within 35mW when multiple chips are lightened
- 5. The maximum ratings are valid for the case of lighting a single chip

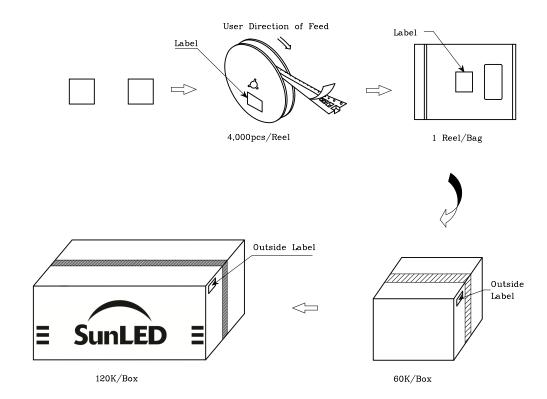
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings

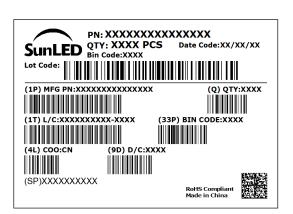
6.Duty Cycle ≤ 1/20, Pulse Width=1ms.

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS





TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- $2. \ Contents \ within \ this \ document \ are \ subject \ to \ improvement \ and \ enhancement \ changes \ without \ notice.$
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The performance of the product(s) should be evaluated and verified by the customer to ensure it can meet the customer's application requirements.
- 6. The contents within this document may not be altered without prior consent by SunLED.
- 7. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp

Oct 21,2023

XDSB9631 V1-X Layout: Maggie L.